Bits		DBs	Time Stamp V
<u>о</u> н	(bulk ad) accustic ad) resonator) same package and (epoxy or polymer) and @pd>"20040924"	US-PGPUB; USPAT; EPO;	2005/02/11
6	530 831 932 533 334 535 536 537 539 540	US-PGPUB; USPAT: EPO:	2005/02/11
3	((fillm adj bulk adj accustic adj resonator) and (piezoelectric same electrode)) and ("Ti" or titanium or "Mo" or molybdenum or "Cr" or chromium or tungeten) and cassive and one	US-PGPUB; USPAT: EPO:	2005/02/11
4 13		US-PGFUS;	2005/02/11
5 20	(bulk ad) acoustic ad) resonator) same package	US-PGPUB:	14.50
9 2	(bulk adj acoustic adj resonatoz) same package and (flip adj chip)	US-PGPUB; USPAT; EPO;	2005/02/11
7 1	([bulk adj acoustic adj resonator) same package) and "high temperature co-fired ceramic"	US-PGPUB; USPAT; EPO;	2005/02/11
60	((bulk adj acquatic adj resonator) same package) and "low temperature co-fired ceramic"	US-PGPUB;	2005/02/11
9 2	(bulk ad) acoustic ad) resonator) and "low temperature co-fired ceramic"	US-PGPUB; USPAI; EPO;	2005/02/11
10 4	(bulk adj acoustic adj resonator) same package and (epoxy or polymer)	US-PGPUB; USPAT: EPO:	2005/02/11
11 0	([film edj bulk edj acquetic edj resonator) and (piezoelectric same electrode)) and ("Ti" or titanium or "Ho" or molybdenum or "Cr" or chromium or tungeten) and passive and ops and Gpd>720090924"	US-PGPUS; USPAT; EPO;	2005/02/11
12 1	(ground ed) plene) and lid and ceramic and substrate and vies and (signel ad) line) and filter and (pd>"10040924"	US-PGPUS: USPAT: EPO:	2005/02/11
13 1	(bulk ad) acoustic adj resonator) same package and @pd>"20040924"	US-PGFUS; USPAT; EPO;	14:58
14 0	(bulk adj acoustic adj resonator) same packaqe and (flip adj chip) and (gd2-20040924"	US-PGPUB; USPAT: EPO:	2005/02/11
15 0	((bulk ad) acoustic ad) resonator) same package) and "high temperature co-fired ceramic" and @pd>"20090924"	US-PGPUB; USPAT; EPO;	2005/02/11
16 0	((bulk ad) acoustic ad) resonator) same package) and "low temperature co-fired ceramic" and Gpd>"20040924"	US-PGPUB; USPAT: EPO;	2005/02/11
17 2	(bulk ad) accustic ad) resonator) and "low temperature co-fired ceramic" and @pd>"20040924"	US-PGFUS; USPAT: EPO;	2005/02/11 14:58
18 25	((film add bulk add acoustic add resonator) and (piezoelectric same electrode)) and ("Il" or titanium or "Mo" or molybdenum or "Cr" or chromium or tungaten) and passive	US-PGPUB; USPAT; EPO;	2005/02/11
19 22	[27/25/414-416.ccls. 439/48,49,50.ccls. 333/188,198,198,198,198,198,198,198,198,198,	US-PGFUB; USPAT; EPO;	2005/02/11
20 4	and (piezoelectric same electrode)) and ("Ti" or t	US-PGPUB; USPAI; EPO;	2005/02/11
21 4	r) and (plezoelectric s	US-PGFUS; USPAT: EPO;	2005/02/11
22 2	(257/125,414-416.ccls, 438/48,59,50.ccls, 333/188,195,195,195,195,195,312,364.ccls.) and ((film adj bulk adj acoustic adj resonator) and (piezoelectric same electrode) and (Film or titanium or FMo" or molybdenum or "Cr" or chromium or tungsten) and passive ) and @pd>"20040924"	US-PGPUB: USPAT; EPO;	2005/02/11
23 40	and (electrode with (titanium or chromium or tungaten))	USPAT: EPO:	2004/09/28
24 321	film adj bulk adj acoustic adj resonator	US-PGPUB; USPAT; EPO;	2004/09/28
25 1	(bulk ad) acoustic adj resonator) and "high temperature co-fired ceramic"	US-PGPUB; USPAT: EPO:	2004/09/27
26 607	Plow temperature co-fired ceramic"	US-PGPUB; USPAT; EPO;	2004/09/27
27 100	"high temperature co-fired ceramic"	USPAT; EPO;	2004/09/27
28 0	low adj temperture adj (co-fixed or (co adj fixed)) adj ceramic	US-PGPUB; USPAI; EPO;	15:11
29 0	high adj temperture adj (co-fired or (co adj fired)) adj ceramic	USPAT; EPO;	2004/09/27
30 173	TACC	US-PGPU3;	2004/09/27

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